

Low Distortion Internally Matched Power GaAs FETs (C-Band)

Features

- Low intermodulation distortion
 - $IM_3 = -44$ dBc at $P_o = 31.5$ dBm,
 - Single carrier level
- High power
 - $P_{1dB} = 42.5$ dBm at 4.4 GHz to 5.0 GHz
- High gain
 - $G_{1dB} = 8.0$ dB at 4.4 GHz to 5.0 GHz
- Broad band internally matched
- Hermetically sealed package

RF Performance Specifications ($T_a = 25^\circ C$)

Characteristics	Symbol	Condition	Unit	Min.	Typ.	Max
Output Power at 1dB Compression Point	P_{1dB}	$V_{DS} = 10V$ $f = 4.4 \sim 5.0$ GHz	dBm	41.5	42.5	–
Power Gain at 1dB Compression Point	G_{1dB}		dB	7.0	8.0	–
Drain Current	I_{DS1}		A	–	4.8	5.5
Gain Flatness	ΔG		dB	–	–	± 0.8
Power Added Efficiency	η_{add}		%	–	31	–
3rd Order Intermodulation Distortion	IM_3	Note 1	dBc	-41	-44	–
Drain Current	I_{DS2}		A	–	4.8	5.5
Channel-Temperature Rise	ΔT_{ch}	$V_{DS} \times I_{DS} \times R_{th}(c-c)$	$^\circ C$	–	–	80

Electrical Characteristics ($T_a = 25^\circ C$)

Characteristic	Symbol	Condition	Unit	Min.	Typ.	Max
Trans-conductance	gm	$V_{DS} = 3V$ $I_{DS} = 6.0A$	mS	–	3600	–
Pinch-off Voltage	V_{GSoff}	$V_{DS} = 3V$ $I_{DS} = 80mA$	V	-2	-3.5	-5.0
Saturated Drain Current	I_{DSS}	$V_{DS} = 3V$ $V_{GS} = 0V$	A	–	11.6	15.0
Gate-Source Breakdown Voltage	V_{GSO}	$I_{GS} = -240\mu A$	V	-5	–	–
Thermal Resistance	$R_{th}(c-c)$	Channel to case	$^\circ C/W$	–	1.4	1.8

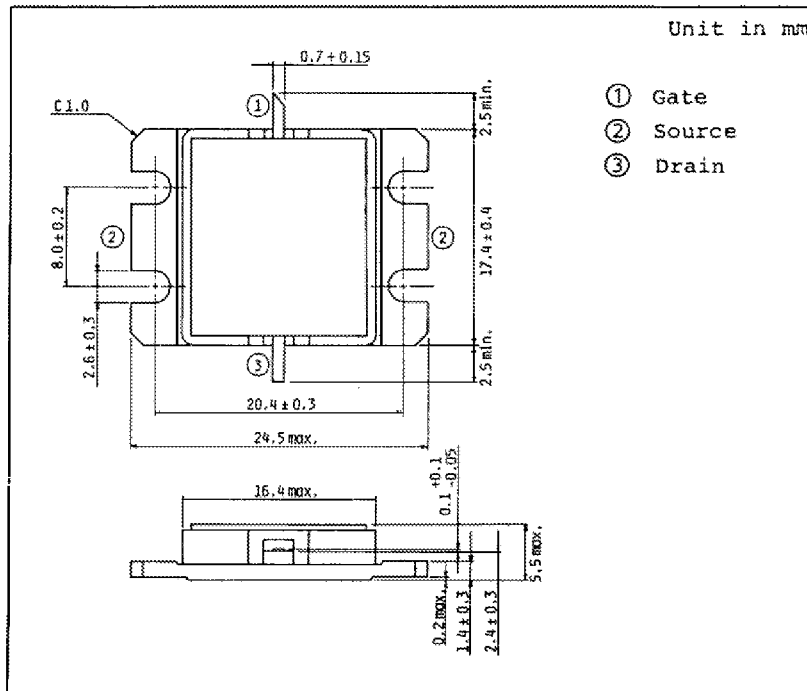
Note 1: 2 tone Test Pout = 31.5dBm Single Carrier Level.

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Absolute Maximum Ratings (Ta = 25° C)

Characteristic	Symbol	Unit	Rating
Drain-Source Voltage	V_{DS}	V	15
Gate-Source Voltage	V_{GS}	V	-5
Drain Current	I_{DS}	A	16
Total Power Dissipation (T _c = 25°C)	P _T	W	70
Channel Temperature	T _{ch}	°C	175
Storage Temperature	T _{stg}	°C	-65~175

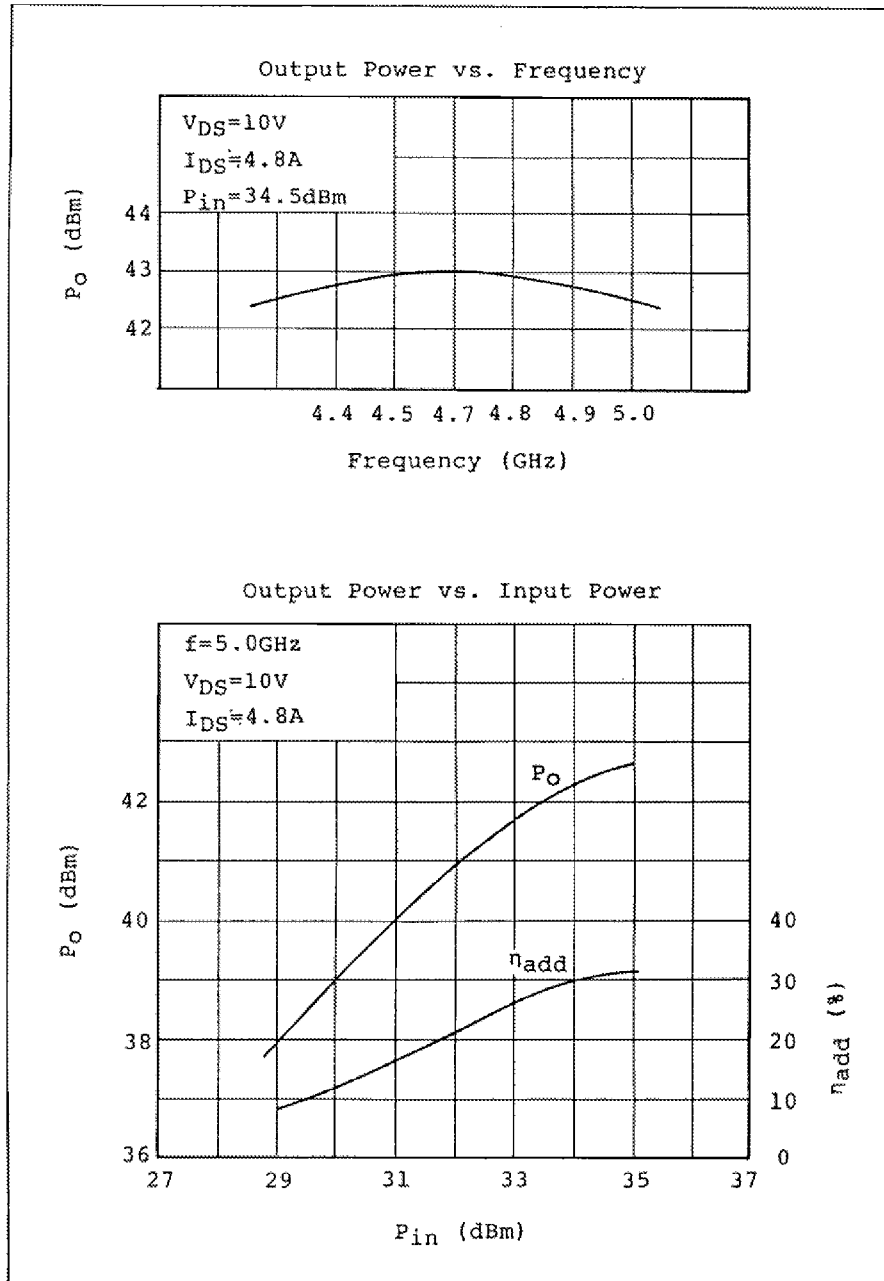
Package Outline (2-16G1B)



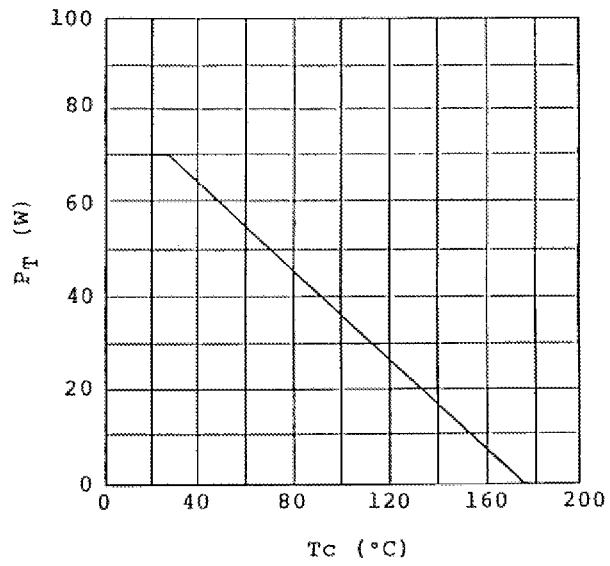
Handling Precautions for Packaged Type

Soldering iron should be grounded and the operating time should not exceed 10 seconds at 260°C.

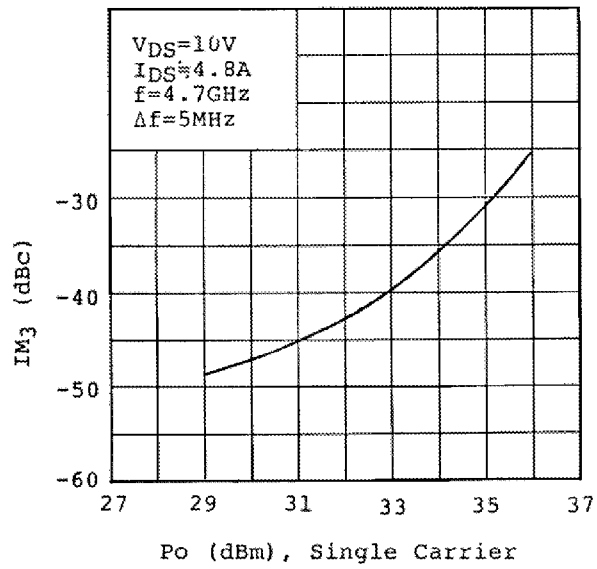
RF Performances



Power Dissipation vs. Case Temperature



IM_3 vs. Output Power Characteristics



TIM4450-16L S-Parameters
(MAGN. and ANGLES)

$V_{DS}=10V, I_{DS}=4.0A$

